

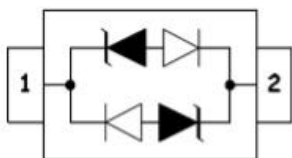
## Description

The SEHXX01D3 is a bi-directional TVS diode, utilizing leading monolithic silicon technology to provide fast response time and low ESD clamping voltage, making this device an ideal solution for protecting voltage sensitive high-speed data lines. The SEHXX01D3 has a low capacitance with a typical value at 0.8pF, and complies with the IEC 61000-4-2 (ESD) standard with  $\pm 30\text{kV}$  air and  $\pm 30\text{kV}$  contact discharge. It is assembled into a lead free SOD-323 package. The small size, low capacitance and high ESD surge protection make SEHXX01D3 an ideal choice to protect cell phone, wireless systems, and communication equipment.

## Features

- 350W peak pulse power (8/20us)
- Ultra low leakage: nA level
- Ultra low capacitance: 0.8pF typical
- Stand-off Voltage: 3.3 V ~ 24 V
- Ultra low clamping voltage
- Complies with following standards:
  - IEC 61000-4-2 (ESD) immunity test
    - Air discharge:  $\pm 30\text{kV}$
    - Contact discharge:  $\pm 30\text{kV}$
  - IEC61000-4-4 (EFT) 40A (5/50ns)
- RoHS Compliant

## Dimensions & Symbol



## Mechanical Characteristics

- Package: SOD-323
- Lead Finish: Matte Tin
- Case Material: “Green” Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminal Connections: See Diagram Below
- Marking Information: See Below

## Applications

- USB Ports
- Smart Phones
- Wireless Systems
- Ethernet 10/100/1000 Base-T

## Marking Information



Details marking code reference customer approval list

## Ordering Information

Part Number	Packaging	Reel Size
SEH3301D3	3000/Tape & Reel	7 inch
SEH0501D3	3000/Tape & Reel	7 inch
SEH0801D3	3000/Tape & Reel	7 inch
SEH1201D3	3000/Tape & Reel	7 inch
SEH1501D3	3000/Tape & Reel	7 inch
SEH2401D3	3000/Tape & Reel	7 inch

Absolute Maximum Ratings ( $T_A=25^{\circ}\text{C}$ , RH=45%-75%, unless otherwise noted)

<b>SEH3301D3</b>			
<b>Parameter</b>	<b>Symbol</b>	<b>Value</b>	<b>Unit</b>
Peak Pulse Power (8/20 $\mu\text{s}$ )	Ppk	350	W
Peak Pulse Current (8/20 $\mu\text{s}$ )	Ipp	20	A
ESD per IEC 61000-4-2 (Air)	VESD	$\pm 30$	kV
ESD per IEC 61000-4-2 (Contact)		$\pm 30$	
Operating Temperature Range	TJ	-55 to +125	$^{\circ}\text{C}$
Storage Temperature Range	Tstg	-55 to +150	$^{\circ}\text{C}$
<b>SEH0501D3</b>			
<b>Parameter</b>	<b>Symbol</b>	<b>Value</b>	<b>Unit</b>
Peak Pulse Power (8/20 $\mu\text{s}$ )	Ppk	350	W
Peak Pulse Current (8/20 $\mu\text{s}$ )	Ipp	17	A
ESD per IEC 61000-4-2 (Air)	VESD	$\pm 30$	kV
ESD per IEC 61000-4-2 (Contact)		$\pm 30$	
Operating Temperature Range	TJ	-55 to +125	$^{\circ}\text{C}$
Storage Temperature Range	Tstg	-55 to +150	$^{\circ}\text{C}$
<b>SEH0801D3</b>			
<b>Parameter</b>	<b>Symbol</b>	<b>Value</b>	<b>Unit</b>
Peak Pulse Power (8/20 $\mu\text{s}$ )	Ppk	350	W
Peak Pulse Current (8/20 $\mu\text{s}$ )	Ipp	15	A
ESD per IEC 61000-4-2 (Air)	VESD	$\pm 30$	kV
ESD per IEC 61000-4-2 (Contact)		$\pm 30$	
Operating Temperature Range	TJ	-55 to +125	$^{\circ}\text{C}$
Storage Temperature Range	Tstg	-55 to +150	$^{\circ}\text{C}$

**SEH1201D3**

Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20 $\mu$ s)	Ppk	350	W
Peak Pulse Current (8/20 $\mu$ s)	Ipp	11	A
ESD per IEC 61000-4-2 (Air)	VESD	$\pm$ 30	kV
ESD per IEC 61000-4-2 (Contact)		$\pm$ 30	
Operating Temperature Range	TJ	-55 to +125	$^{\circ}$ C
Storage Temperature Range	Tstg	-55 to +150	$^{\circ}$ C

**SEH1501D3**

Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20 $\mu$ s)	Ppk	350	W
Peak Pulse Current (8/20 $\mu$ s)	Ipp	10	A
ESD per IEC 61000-4-2 (Air)	VESD	$\pm$ 30	kV
ESD per IEC 61000-4-2 (Contact)		$\pm$ 30	
Operating Temperature Range	TJ	-55 to +125	$^{\circ}$ C
Storage Temperature Range	Tstg	-55 to +150	$^{\circ}$ C

**SEH2401D3**

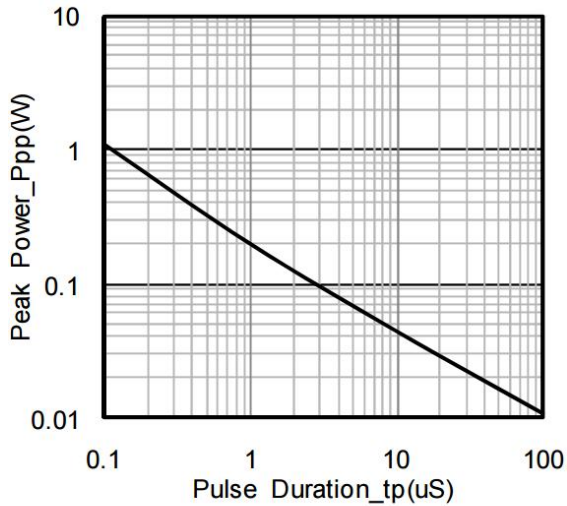
Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20 $\mu$ s)	Ppk	350	W
Peak Pulse Current (8/20 $\mu$ s)	Ipp	6	A
ESD per IEC 61000-4-2 (Air)	VESD	$\pm$ 30	kV
ESD per IEC 61000-4-2 (Contact)		$\pm$ 30	
Operating Temperature Range	TJ	-55 to +125	$^{\circ}$ C
Storage Temperature Range	Tstg	-55 to +150	$^{\circ}$ C

Electrical Characteristics (T<sub>A</sub>=25 °C)

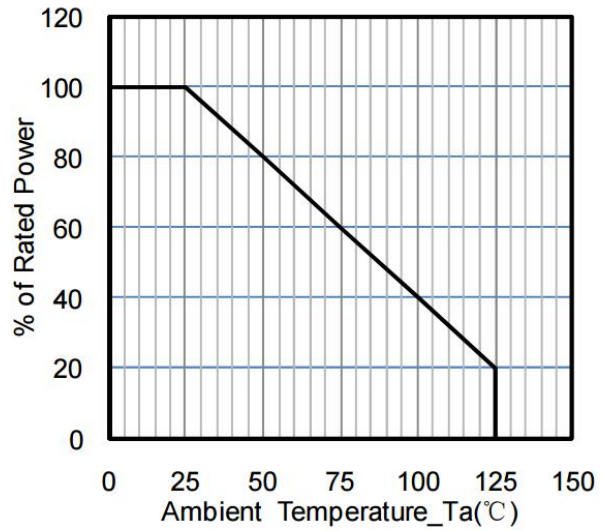
SEH3301D3						
Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Working Voltage	VRWM			3.3	V	
Breakdown Voltage	VBR	4.0			V	IT = 1mA
Reverse Leakage Current	IR			20	uA	VRWM = 3.3V
Clamping Voltage	VC		7.0		V	IPP = 1A (8 x 20uS pulse)
Clamping Voltage	VC			19	V	IPP = 20A (8 x 20uS pulse)
Junction Capacitance	CJ		0.8		pF	VR = 0V, f = 1MHz
SEH0501D3						
Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Working Voltage	VRWM			5	V	
Breakdown Voltage	VBR	6.2			V	IT = 1mA
Reverse Leakage Current	IR			5	uA	VRWM = 5V
Clamping Voltage	VC		9.8		V	IPP = 1A (8 x 20uS pulse)
Clamping Voltage	VC			21	V	IPP = 17A (8 x 20uS pulse)
Junction Capacitance	CJ		0.8		pF	VR = 0V, f = 1MHz
SEH0801D3						
Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Working Voltage	VRWM			8	V	
Breakdown Voltage	VBR	8.5			V	IT = 1mA
Reverse Leakage Current	IR			2	uA	VRWM = 8V
Clamping Voltage	VC		13.5		V	IPP = 1A (8 x 20uS pulse)
Clamping Voltage	VC			25	V	IPP = 15A (8 x 20uS pulse)
Junction Capacitance	CJ		0.8		pF	VR = 0V, f = 1MHz

SEH1201D3						
Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Working Voltage	VRWM			12	V	
Breakdown Voltage	VBR	13.3			V	IT = 1mA
Reverse Leakage Current	IR			1	uA	VRWM = 12V
Clamping Voltage	VC		19		V	IPP = 1A (8 x 20uS pulse)
Clamping Voltage	VC			30	V	IPP = 11A (8 x 20uS pulse)
Junction Capacitance	CJ		0.8		pF	VR = 0V, f = 1MHz
SEH1501D3						
Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Working Voltage	VRWM			15	V	
Breakdown Voltage	VBR	16.7			V	IT = 1mA
Reverse Leakage Current	IR			1	uA	VRWM = 15V
Clamping Voltage	VC		24		V	IPP = 1A (8 x 20uS pulse)
Clamping Voltage	VC			32	V	IPP = 10A (8 x 20uS pulse)
Junction Capacitance	CJ		0.8		pF	VR = 0V, f = 1MHz
SEH2401D3						
Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Working Voltage	VRWM			24	V	
Breakdown Voltage	VBR	26.7			V	IT = 1mA
Reverse Leakage Current	IR			1	uA	VRWM = 24V
Clamping Voltage	VC		43		V	IPP = 1A (8 x 20uS pulse)
Clamping Voltage	VC			43	V	IPP = 6A (8 x 20uS pulse)
Junction Capacitance	CJ		0.8		pF	VR = 0V, f = 1MHz

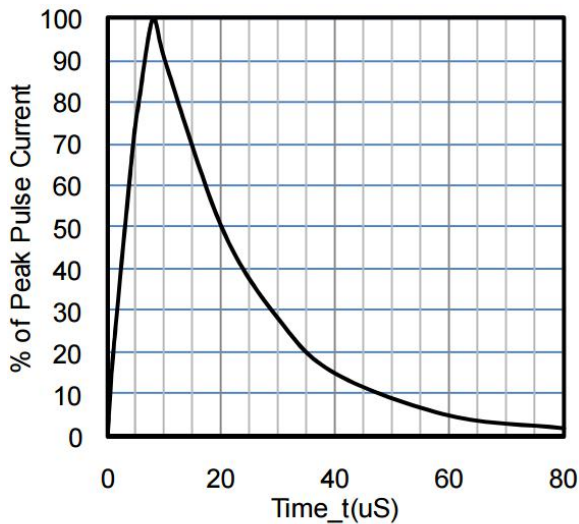
Typical Performance Characteristics ( $T_A=25^{\circ}\text{C}$  unless otherwise Specified)



Peak Pulse Power vs. Pulse Time



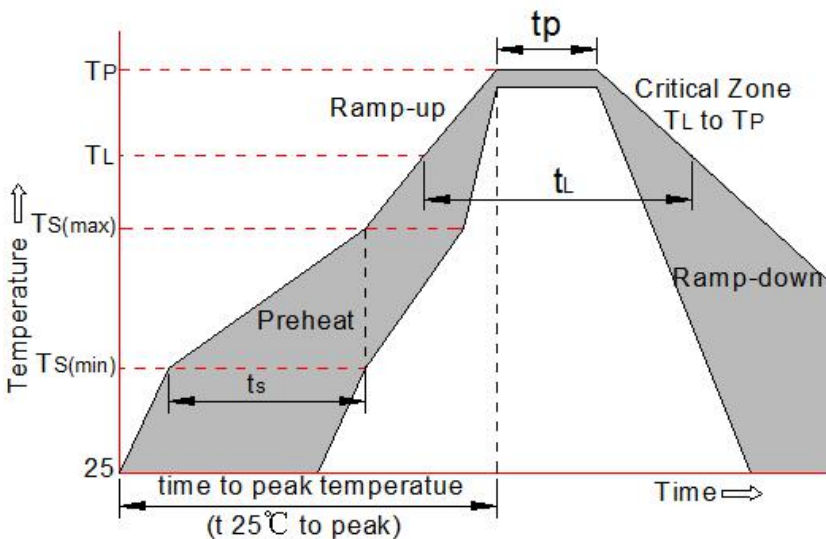
Power Derating Curve



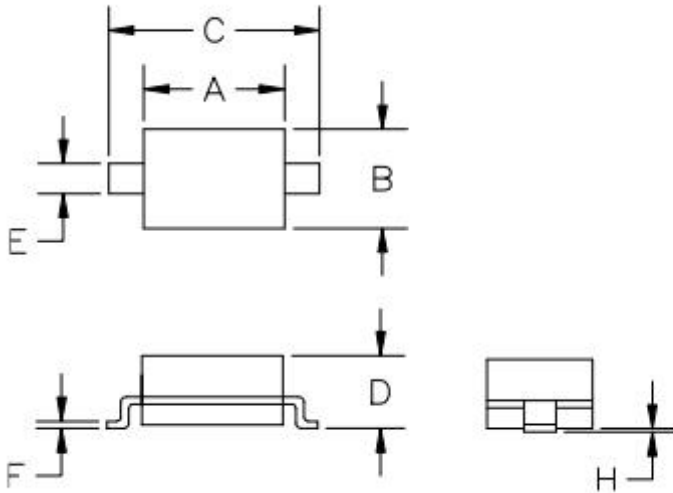
8 X 20uS Pulse Waveform

**Soldering Parameters**

Reflow Condition		Pb-Free assembly (see as below)
Pre Heat	-Temperature Min ( $T_{s(min)}$ )	+150°C
	-Temperature Max( $T_{s(max)}$ )	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp ( $T_L$ ) to peak)		3°C/sec. Max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature( $T_L$ ) (Liquid us)	+217°C
	-Temperature( $t_L$ )	60-150 secs.
Peak Temp ( $T_p$ )		+260(+0/-5)°C
Time within 5°C of actual Peak Temp ( $t_p$ )		30 secs. Max
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp ( $T_p$ )		8 min. Max
Do not exceed		+260°C

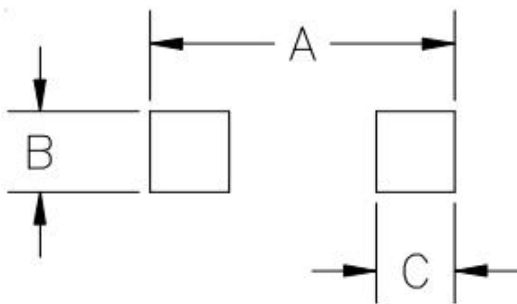


Package Mechanical Data



SYM	DIMENSIONS			
	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.50	1.80	0.060	0.071
B	1.20	1.40	0.045	0.054
C	2.30	2.70	0.090	0.107
D	-	1.10	-	0.043
E	0.30	0.40	0.012	0.016
F	0.10	0.25	0.004	0.010
H	-	0.10	-	0.004

Suggested Land Pattern



SYM	DIMENSIONS	
	MILLIMETERS	INCHES
A	3.15	0.120
B	0.80	0.031
C	0.80	0.031

Contact Information

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